650V, 45A, V<sub>CE(on)</sub>= 1.9V Typical

## Ultra Fast NPT - IGBT<sup>®</sup> with Ultra Soft Recovery Diode

The Ultra Fast 650V NPT-IGBT<sup>®</sup> family of products is the newest generation of IGBTs optimized for outstanding ruggedness and best trade-off between conduction and switching losses.

## Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant 🥒
- Smooth Reverse Recovery
- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current
- Snap-free Switching

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

## MAXIMUM RATINGS

All Ratings:	$T_{C} = 25^{\circ}C$	unless	otherwise	specified.

Symbol	Parameter	Ratings	Unit
V <sub>CES</sub>	Collector Emitter Voltage	650	V
V <sub>GE</sub>	Gate-Emitter Voltage	±30	V
I <sub>C1</sub>	Continuous Collector Current @ T <sub>c</sub> = 25°C	118	
I <sub>C2</sub>	Continuous Collector Current @ T <sub>c</sub> = 110°C	56	А
I <sub>CM</sub>	Pulsed Collector Current ①	224	
SCWT	Short Circuit Withstand Time: $V_{ce}$ = 325V, $V_{ge}$ = 15V, $T_c$ =125°C	10	μs
P <sub>D</sub>	Total Power Dissipation @ $T_c = 25^{\circ}C$	543	W
T_,T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C
TL	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	C

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage ( $V_{GE} = 0V$ , $I_{C} = 350\mu$ A)	650			
V <sub>GE(TH)</sub>	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25^{\circ}\text{C})$	3.5	5.0	6.5	
	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{c}$ = 45A, $T_{j}$ = 25°C)		1.9	2.4	Volts
V <sub>CE(ON)</sub>	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{c}$ = 45A, $T_{j}$ = 125°C)		2.4		
()	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{c}$ = 90A, $T_{j}$ = 25°C)		2.6		
	Collector Cut-off Current (V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C) <sup>(2)</sup>		20	350	
I <sub>CES</sub>	Collector Cut-off Current (V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 125°C) <sup>(2)</sup>		200		μA
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>GE</sub> = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.









#### **DYNAMIC CHARACTERISTICS**

#### APT45GR65B2DU30

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ies</sub>	Input Capacitance	Capacitance		2900		
C <sub>oes</sub>	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		548		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		268		I.
V <sub>GEP</sub>	Gate to Emitter Plateau Voltage	Gate Charge	1	7.5		V
Q <sub>q</sub> 3	Total Gate Charge	 V <sub>GF</sub> = 15V		150	203	
Q <sub>ge</sub>	Gate-Emitter Charge	V <sub>ce</sub> = 325V		18	24	nC
Q <sub>gc</sub>	Gate- Collector Charge	– I <sub>c</sub> = 45A		74	100	
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (25°C)	1	15		
t,	Current Rise Time	V <sub>cc</sub> = 433V		32		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GF</sub> = 15V		100		ns
t,	Current Fall Time	I <sub>c</sub> = 45A		50		
E <sub>on2</sub> 5	Turn-On Switching Energy	$R_{G} = 4.3\Omega^{4}$		1100	1650	
E <sub>off</sub>	Turn-Off Switching Energy	T_ = +25°C		540	870	μJ
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (125°C)	1	15		
t <sub>r</sub>	Current Rise Time	V <sub>cc</sub> = 433V		32		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		123		ns
t <sub>r</sub>	Current Fall Time	I <sub>c</sub> = 45A		52		
E <sub>on2</sub> 5	Turn-On Switching Energy	$R_{g} = 4.3\Omega^{4}$		1600	2400	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>1</sub> = +125°C		800	1160	μJ

#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
R <sub>ejc</sub>	Junction to Case Thermal Resistance (IGBT)			0.23	°C/W
	Junction to Case Thermal Resistance (Diode)			0.80	
R <sub>eja</sub>	Junction to Ambient Thermal Resistance			40	
	Dockage Weight		0.22		oz
W <sub>T</sub>	Package Weight		6.2		g

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width <  $380\mu s$ , duty cycle < 2%.

3 See Mil-Std-750 Method 3471.

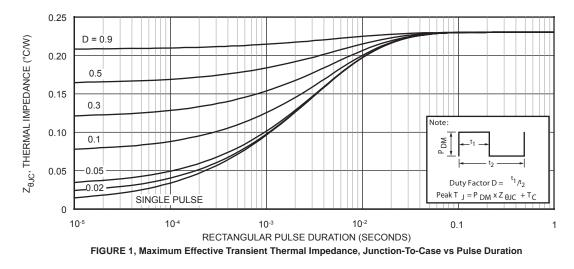
4 R<sub>6</sub> is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E<sub>on2</sub> is the energy loss at turn-on and includes the charge stored in the freewheeling diode.

 $6 E_{off}$  is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

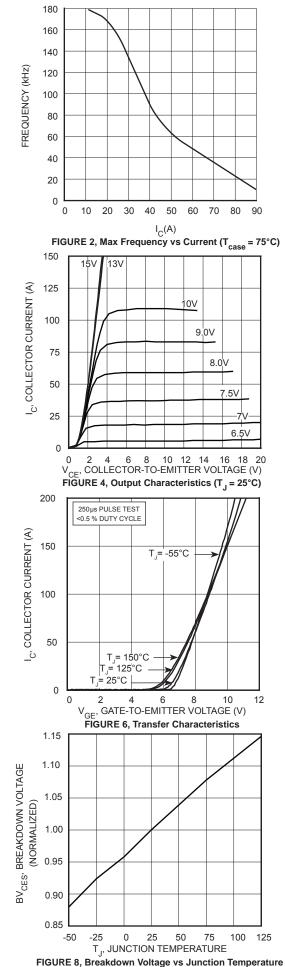
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### **TYPICAL PERFORMANCE CURVES**



#### **TYPICAL PERFORMANCE CURVES**

#### APT45GR65B2DU30



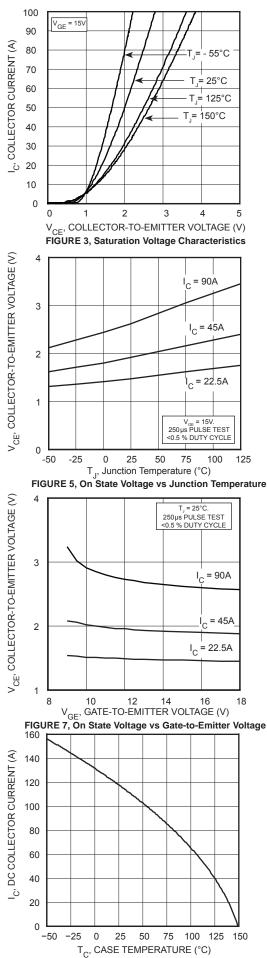
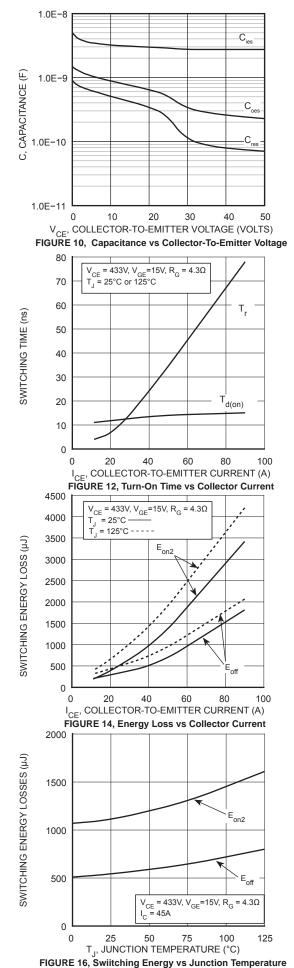


FIGURE 9, DC Collector Current vs Case Temperature

#### **TYPICAL PERFORMANCE CURVES**

#### APT45GR65B2DU30



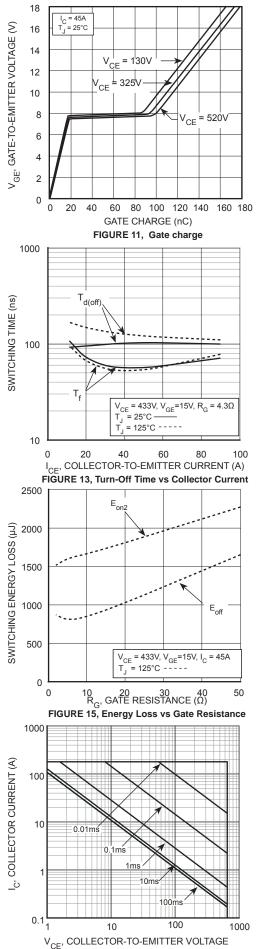


FIGURE 17, Minimum Switching Safe Operating Area

# **ULTRA SOFT RECOVERY ANTI-PARALLEL DIODE**

### **MAXIMUM RATINGS**

All Ratings:  $T_{C}$  = 25°C unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT45GR65B2DU30	Unit
I <sub>F(AV)</sub>	Maximum Average Forward Current ( $T_c = 82^{\circ}C$ , Duty Cycle = 0.5)	30	
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	41	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current (T <sub>J</sub> = 45°C, 8.3ms)	210	

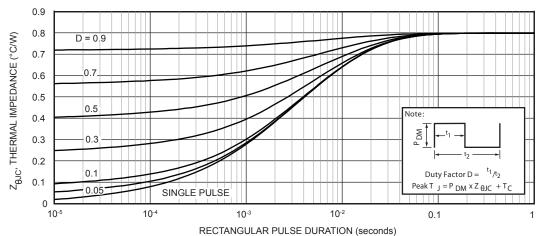
### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
		I <sub>F</sub> = 30A		3		
V <sub>F</sub>	V <sub>F</sub> Forward Voltage	I <sub>F</sub> = 60A		3.9		Volts
		I <sub>F</sub> = 60A, T <sub>J</sub> = 125°C		3.5		

#### **DYNAMIC CHARACTERISTICS**

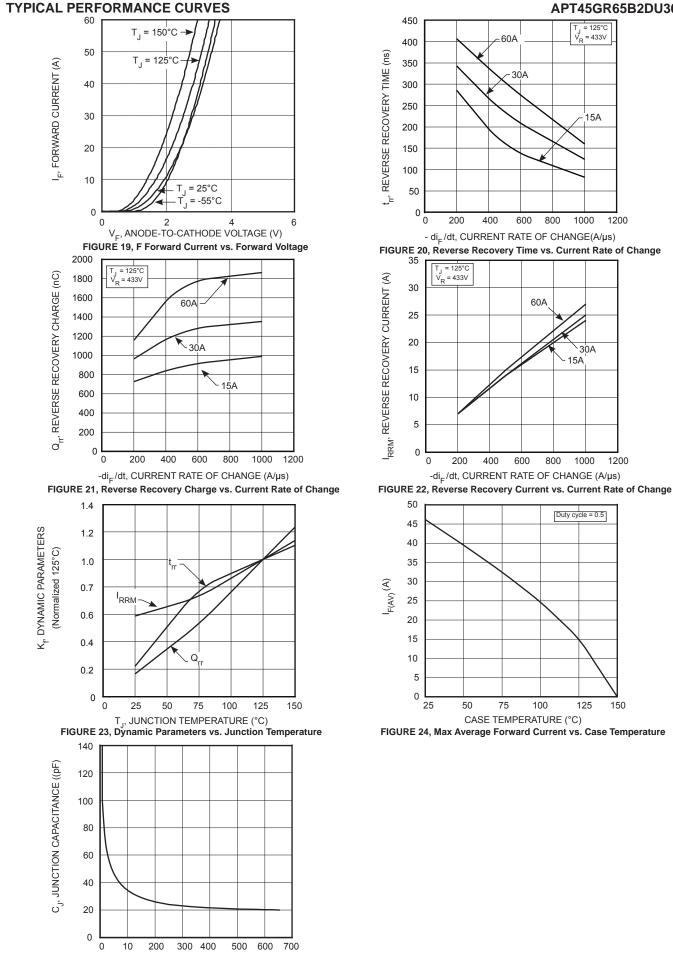
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_{_{\rm F}}$ = 1.0A, dif/dt= -100 A/µs, $V_{_{\rm R}}$ = 30V, $T_{_{\rm J}}$ = 25°C		28		ns
t <sub>rr</sub>	Reverse Recovery Time	I <sub>=</sub> = 30 Amps		80		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dif/dt= -200 A/µs		110		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current	V <sub>R</sub> = 433 Volts		3		Amps
E <sub>rr</sub>	Reverse Recovery Energy	T <sub>j</sub> = 25°C		2		μJ
t <sub>rr</sub>	Reverse Recovery	I <sub>=</sub> = 30 Amps		343		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dif/dt= -200 A/µs		965		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current	$V_{R} = 433$ Volts		7		Amps
E <sub>rr</sub>	Reverse Recovery Energy	T <sub>j</sub> = 125°C		88		μJ
t <sub>rr</sub>	Reverse Recovery	I <sub>=</sub> = 30 Amps		124		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dif/dt= -1000 A/µs		1355		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current	V <sub>R</sub> = 433 Volts T <sub>j</sub> = 125°C		24		Amps
E <sub>rr</sub>	Reverse Recovery Energy			211		μJ
S	Softness Factor $(t_b/t_a)$	$I_{_{\rm F}}$ = 15A, dif/dt= -1000 A/µs, V $_{_{\rm R}}$ = 800V, T $_{_{\rm J}}$ = 125°C		2		

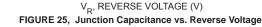
## **TYPICAL PERFORMANCE CURVES**



052-6435 Rev A 6-2014

RECTANGULAR PULSE DURATION (seconds) FIGURE 18, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION





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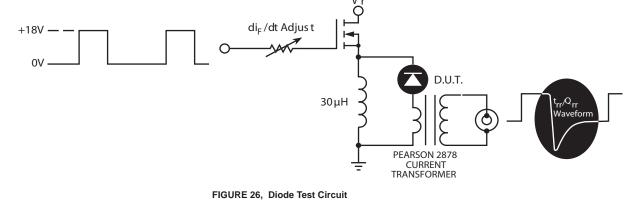
15A

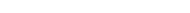
1200

1200

150

#### APT45GR65B2DU30





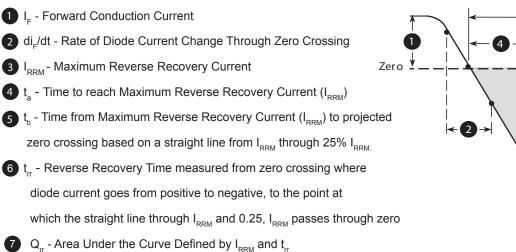
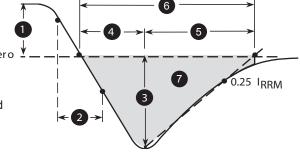
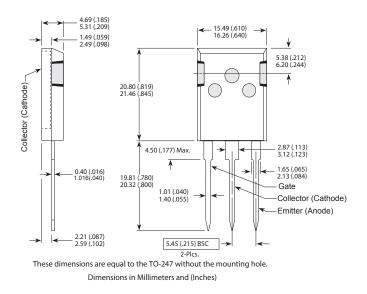


FIGURE 27, Diode Reverse Recovery Waveform Definition



## T-MAX<sup>®</sup> (B2) Package Outline



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